

Technology Voucher Programme (“TVP”)

Declaration and Undertaking

Application reference number: TVP/_____/____

1. I/we refer to the application bearing the application reference number stated above (“**Application**”) which I/we have submitted to the Government of the Hong Kong Special Administrative Region (“**Government**”) for financial support from the TVP in order to carry out a project as described in the Application (“**Project**”).
2. I/we, hereby confirm and declare that :
 - (a) I/we have commenced / will commence[^] the Project on _____(dd/mm/yyyy)
[actual commencement date]
 - (b) I/we fully understand that:
 - (i) the Application is under processing at the time stated in (a) above by the Government acting through the Innovation and Technology Commission and may or may not be approved by the Government eventually; and
 - (ii) if the Application is approved, I/we may or may not be granted the full amount of funding support requested in the Application.
3. I/we hereby undertake **not to claim any compensation of whatsoever nature from the Government** for any damages, costs, losses, charges and expenses sustained or incurred, which in any case arise directly or indirectly from, or as a result of, or in connection with, or which relate in any way to the Government’s rejection of the Application or my/our not being granted the funding requested in the Application in full or in part.

Signed by the Applicant Entity /

Signed by an authorised signatory for

and on behalf of the Applicant Entity

with Applicant Entity’s chop (if any)^{^*} : _____

Name of the Applicant Entity : _____

**Name (as shown on HKID Card /
Passport) and post title of the
signatory (where applicable) :** _____

Telephone number : _____

Date (dd/mm/yyyy) : _____

[^] Please delete as appropriate

^{*} Should be the same signatory as the one signing the Application Form

Note: Please submit the duly signed original copy of this document by **post** to the following address **no later than five working days** after the actual commencement date of the **Project** stated in paragraph 2(a) above:

Technology Voucher Programme Secretariat
Innovation and Technology Commission
10/F, Rykadan Capital Tower, 135 Hoi Bun Road
Kwun Tong, Kowloon, Hong Kong